

DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

(X) Original () Supplemental () Substitute () PCT () Design

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: METHOD AND APPARATUS FOR DETERMINING PROCESSING SIZE OF BONDING MATERIAL

of which is described and claimed in:

- (X) the attached specification, or
 () the specification in the application Serial No. _____ filed _____;
 and with amendments through _____ (if applicable), or
 () the specification in International Application No. PCT/_____, filed _____, and as amended
 on _____ (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	2002-200971	July 10, 2002	Yes
Japan	2003-192147	July 4, 2003	Yes

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; and Michael S. Huppert, Reg. No. 40,268, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from _____
OGASAWARA PATENT OFFICE, as to any action to be taken in the U.S. Patent and Trademark Office
regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons
from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to Customer No: <p style="text-align: center;">000513</p> <p style="text-align: center;">PATENT TRADEMARK OFFICE</p>	Direct Telephone Calls to: WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 Washington, D.C. 20006-1021 Phone:(202) 721-8200 Fax:(202) 721-8250
--	---

Full Name of First Inventor	FAMILY NAME YAMAMOTO	FIRST GIVEN NAME Akihiro	SECOND GIVEN NAME
Residence & Citizenship	CITY Kobe	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 1-10-101-3401, Naka, Koyo-cho, Higashinada-ku,	CITY Kobe-shi, Hyogo-ken, Japan	STATE OR COUNTRY 658-0032

Full Name of Second Inventor	FAMILY NAME KOBAYASHI	FIRST GIVEN NAME Sakae	SECOND GIVEN NAME
Residence & Citizenship	CITY Hirakata	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 4-18-10, Deguchi,	CITY Hirakata-shi, Osaka-fu, Japan	STATE OR COUNTRY 573-0065

Full Name of Third Inventor	FAMILY NAME EGUCHI	FIRST GIVEN NAME Shinzou	SECOND GIVEN NAME
Residence & Citizenship	CITY Kyotanabe	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 3-4-15, Kasumizaka,	CITY Kyotanabe-shi, Kyoto-fu, Japan	STATE OR COUNTRY 610-0352

Full Name of Fourth Inventor	FAMILY NAME MURATA	FIRST GIVEN NAME Kazuhiro	SECOND GIVEN NAME
Residence & Citizenship	CITY Nara	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 2-3-1-209, Sakyō,	CITY Nara-shi, Nara-ken, Japan	STATE OR COUNTRY 631-0801

Full Name of Fifth Inventor	FAMILY NAME YOSHIDA	FIRST GIVEN NAME Kouichi	SECOND GIVEN NAME
Residence & Citizenship	CITY Moriguchi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 5-22-13-313, Toda-cho, Moriguchi-shi, Osaka-fu, Japan	CITY	STATE OR COUNTRY 570-0014

Full Name of Sixth Inventor	FAMILY NAME	FIRST GIVEN NAME	SECOND GIVEN NAME
Residence & Citizenship	CITY	STATE OR COUNTRY	COUNTRY OF CITIZENSHIP
Post Office Address	ADDRESS	CITY	STATE OR COUNTRY ZIP CODE

Full Name of Seventh Inventor	FAMILY NAME	FIRST GIVEN NAME	SECOND GIVEN NAME
Residence & Citizenship	CITY	STATE OR COUNTRY	COUNTRY OF CITIZENSHIP
Post Office Address	ADDRESS	CITY	STATE OR COUNTRY ZIP CODE

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor Akihiro Yamamoto Date July 4, 2003
2nd Inventor Sakae Kobayashi Akihiro YAMAMOTO Date July 4, 2003
3rd Inventor Shinzou Eguchi Sakae KOBAYASHI Date July 4, 2003
4th Inventor Kazuhiro Murata Shinzou EGUCHI Date July 4, 2003
5th Inventor Kouichi Yoshida Kazuhiro MURATA Date July 4, 2003
6th Inventor Kouichi YOSHIDA Date _____
7th Inventor _____ Date _____

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date _____

Applicant Reference Number FP-1274 Atty Docket No. _____

Title of Invention METHOD AND APPARATUS FOR DETERMINING PROCESSING SIZE OF BONDING MATERIAL